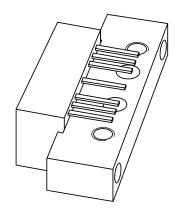
## DISCRETE SEMICONDUCTORS

# DATA SHEET



## **BGY588N** 550 MHz, 34.5 dB gain push-pull amplifier

Product specification Supersedes data of 2000 Feb 14 2001 Oct 22



## 550 MHz, 34.5 dB gain push-pull amplifier

**BGY588N** 

#### **FEATURES**

- · Excellent linearity
- · Extremely low noise
- Silicon nitride passivation
- Rugged construction
- TiPtAu metallized crystals ensure optimal reliability.

#### **APPLICATIONS**

CATV systems in the 40 to 550 MHz frequency range and intended for use as a line-extender.

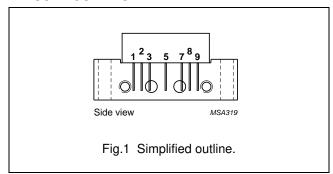
#### **DESCRIPTION**

Hybrid amplifier module in a SOT115J package operating with a voltage supply of 24 V (DC).

#### **PINNING - SOT115J**

PIN	DESCRIPTION	
1	input	
2	common	
3	common	
5	+V <sub>B</sub>	
7	common	
8	common	
9	output	

#### **PIN CONFIGURATION**



#### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Gp	power gain	f = 50 MHz	34	34.5	35	dB
		f = 550 MHz	35	35.5	36	dB
I <sub>tot</sub>	total current consumption (DC)	V <sub>B</sub> = 24 V	310	325	340	mA

#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER		MAX.	UNIT
V <sub>i</sub>	RF input voltage	-	55	dBmV
T <sub>stg</sub>	storage temperature		+100	°C
T <sub>mb</sub>	operating mounting base temperature		+100	°C

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#### **CHARACTERISTICS**

Bandwidth 40 to 550 MHz;  $V_B$  = 24 V;  $T_{case}$  = 35 °C;  $Z_S$  =  $Z_L$  = 75  $\Omega$ 

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Gp	power gain	f = 50 MHz	34	34.5	35	dB
		f = 550 MHz	35	35.5	36	dB
SL	slope cable equivalent	f = 40 to 550 MHz	0.5	1	1.5	dB
FL	flatness of frequency response	f = 40 to 550 MHz	_	_	±0.3	dB
S <sub>11</sub>	input return losses	f = 40 to 80 MHz	20	_	_	dB
		f = 80 to 160 MHz	19	_	_	dB
		f = 160 to 550 MHz	18	_	_	dB
S <sub>22</sub>	output return losses	f = 40 to 80 MHz	20	_	_	dB
		f = 80 to 160 MHz	19	_	_	dB
		f = 160 to 550 MHz	18	_	_	dB
СТВ	composite triple beat	77 channels flat; V <sub>o</sub> = 44 dBmV; measured at 547.25 MHz	_	_	-57	dB
X <sub>mod</sub>	cross modulation	77 channels flat; V <sub>o</sub> = 44 dBmV; measured at 55.25 MHz	-	_	-59	dB
CSO	composite second order distortion	77 channels flat; V <sub>o</sub> = 44 dBmV; measured at 548.5 MHz	_	_	-62	dB
d <sub>2</sub>	second order distortion	note 1	_	_	-74	dB
Vo	output voltage	d <sub>im</sub> = -60 dB; note 2	61	_	_	dBmV
F	noise figure	f = 50 MHz	_	_	5	dB
		f = 550 MHz	_	_	6	dB
I <sub>tot</sub>	total current consumption (DC)	value; V <sub>B</sub> = 24 V; note 3	310	325	340	mA

#### **Notes**

```
 \begin{array}{ll} \text{1.} & f_p = 55.25 \text{ MHz}; \ V_p = 44 \text{ dBmV}; \\ & f_q = 493.25 \text{ MHz}; \ V_q = 44 \text{ dBmV}; \\ & \text{measured at } f_p + f_q = 548.5 \text{ MHz}. \end{array}
```

2. Measured according to DIN45004B;

```
\begin{split} f_p &= 540.25 \text{ MHz; } V_p = V_o; \\ f_q &= 547.25 \text{ MHz; } V_q = V_o - 6 \text{ dB;} \\ f_r &= 549.25 \text{ MHz; } V_r = V_o - 6 \text{ dB;} \\ \text{measured at } f_p + f_q - f_r = 538.25 \text{ MHz.} \end{split}
```

3. The module normally operates at  $V_B = 24 \text{ V}$ , but is able to withstand supply transients up to 30 V.

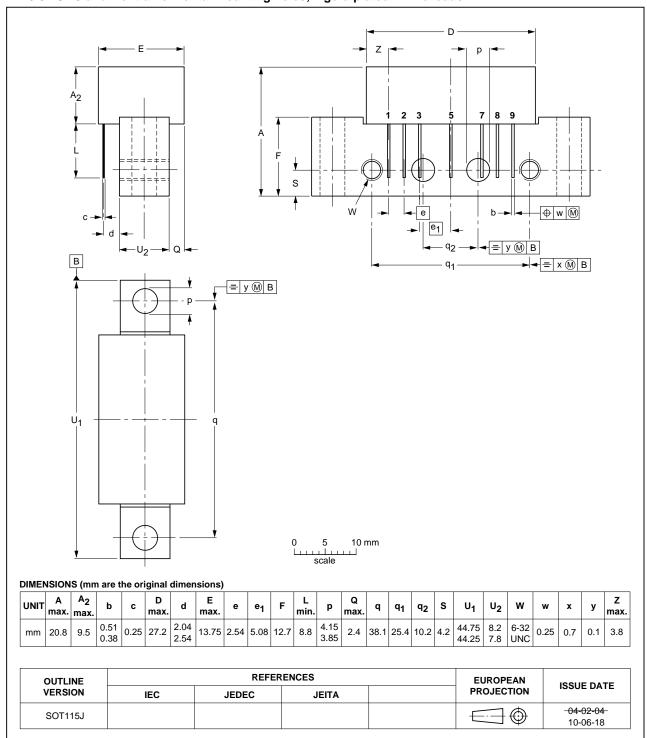
## 550 MHz, 34.5 dB gain push-pull amplifier

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#### **PACKAGE OUTLINE**

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J



## 550 MHz, 34.5 dB gain push-pull amplifier

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#### **DATA SHEET STATUS**

DOCUMENT STATUS(1)	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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2001 Oct 22

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#### **Customer notification**

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#### **Contact information**

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